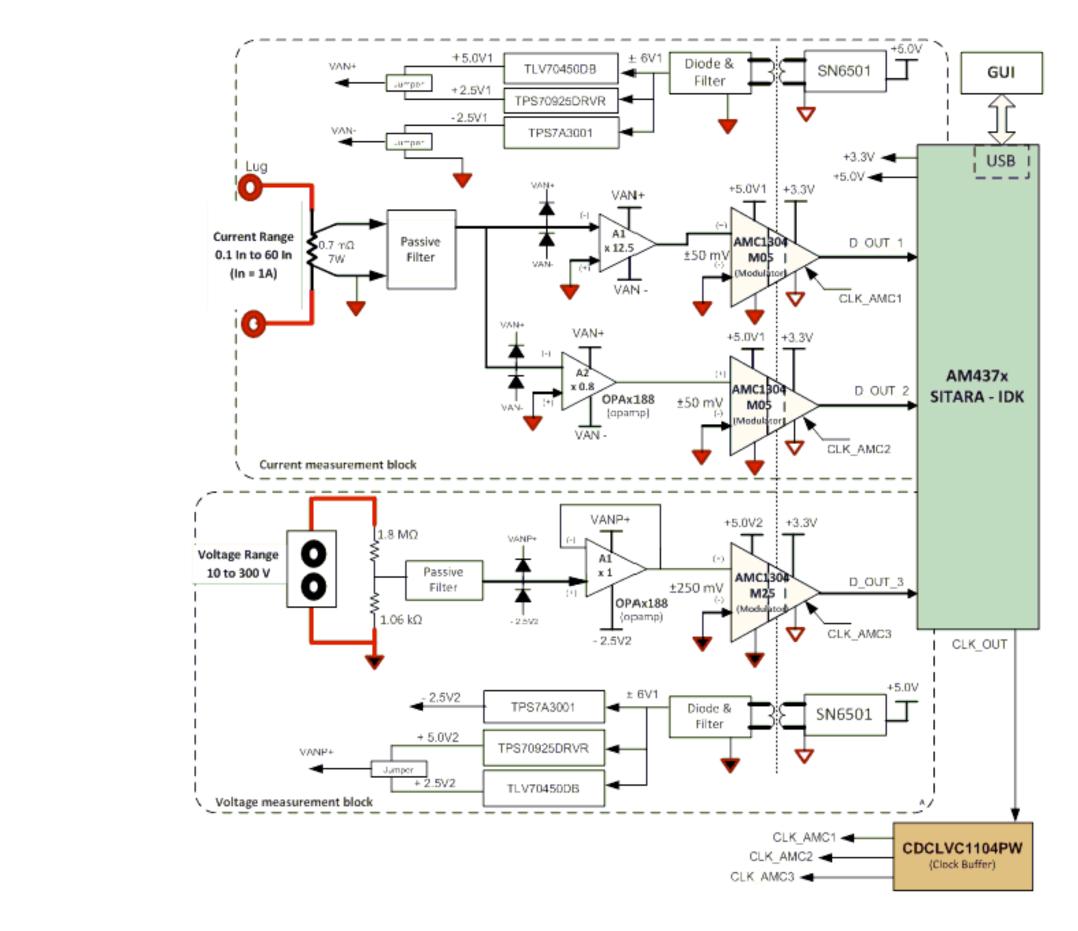
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Page 2	BLOCK DIAGRAM							
Page 3	MODULATORS_CURRENT							
							Revision History	
						Revision	Notes	
Page 4	AM437X IDK INTERFACE							
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Page 5	POWER SUPPLY_CURRENT	MEASUREMENT						
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Page 6	MODULATOR_VOLTAGE							
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Page 7	POWER SUPPLY_VOLTAGE	MEASUREMENT						
Page 8	HARDWARE - MISCELLANE	OUS						
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Revision History Revision

Designed for: Public Release | Mod. Date: 12/8/2015 | Project Title: ICVM Using AMC1304 and SITARA Controller

Assembly Variant: 001
File: Cover Sheet_ANSI-B.SchDoc

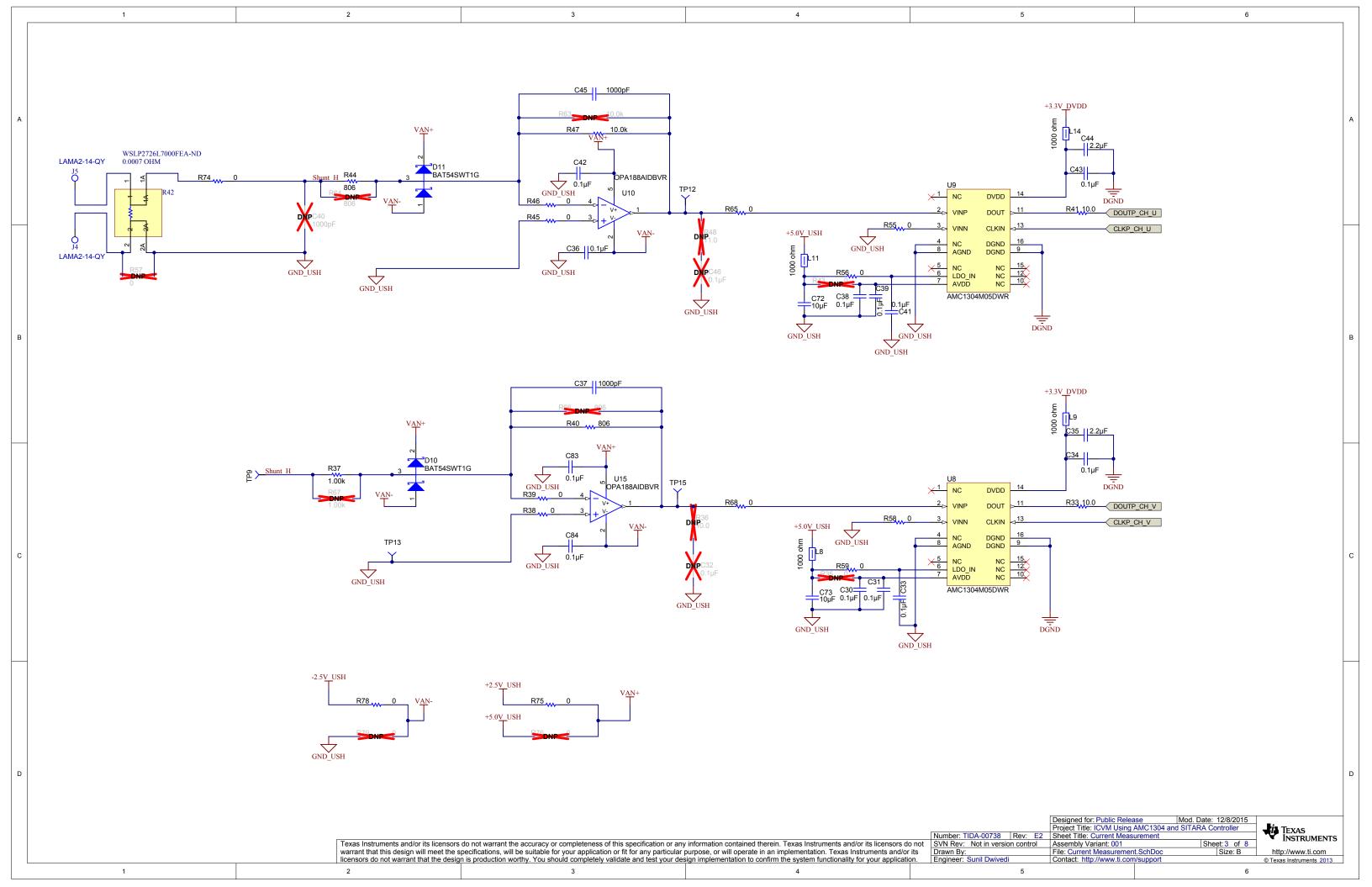
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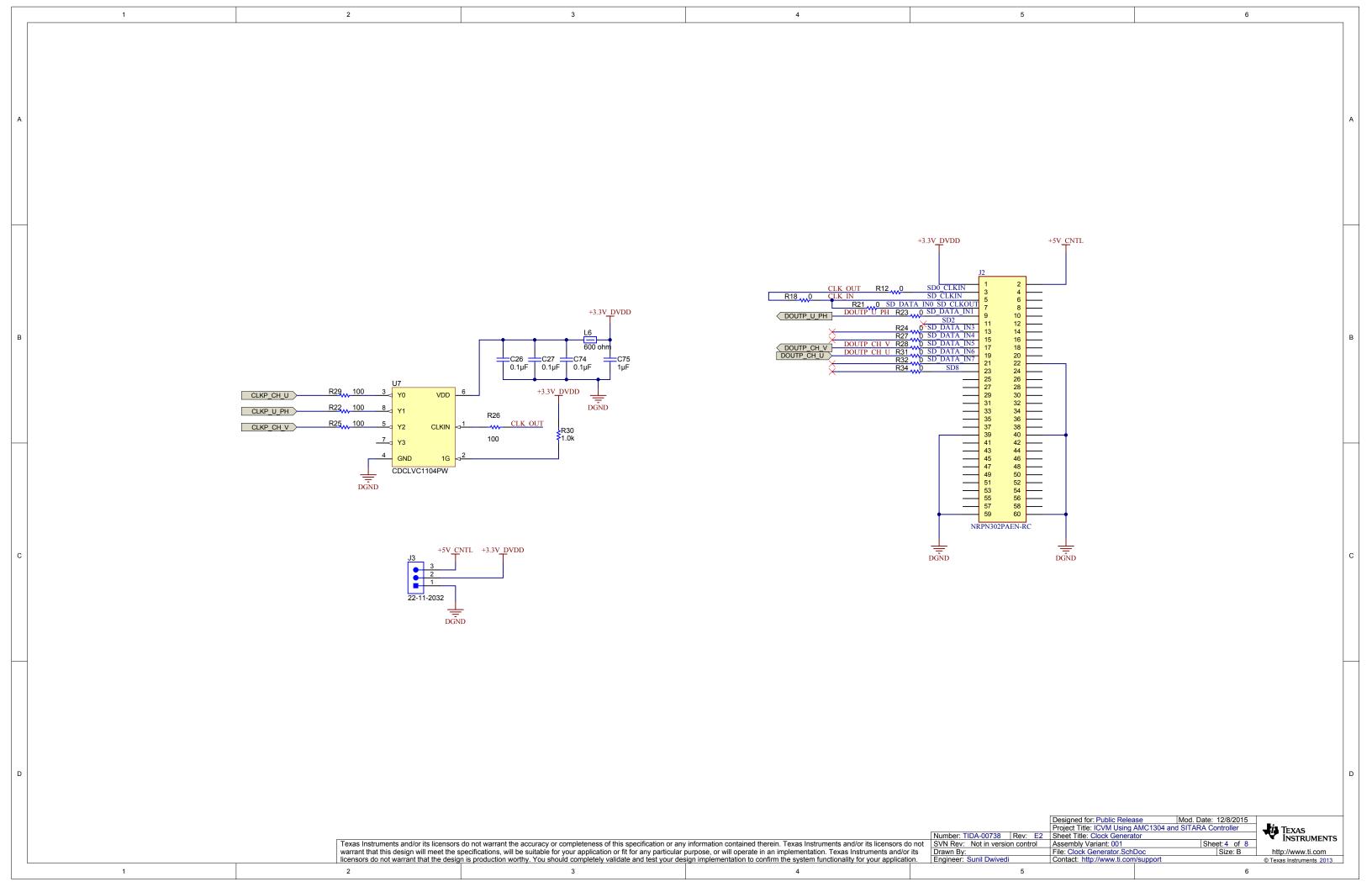
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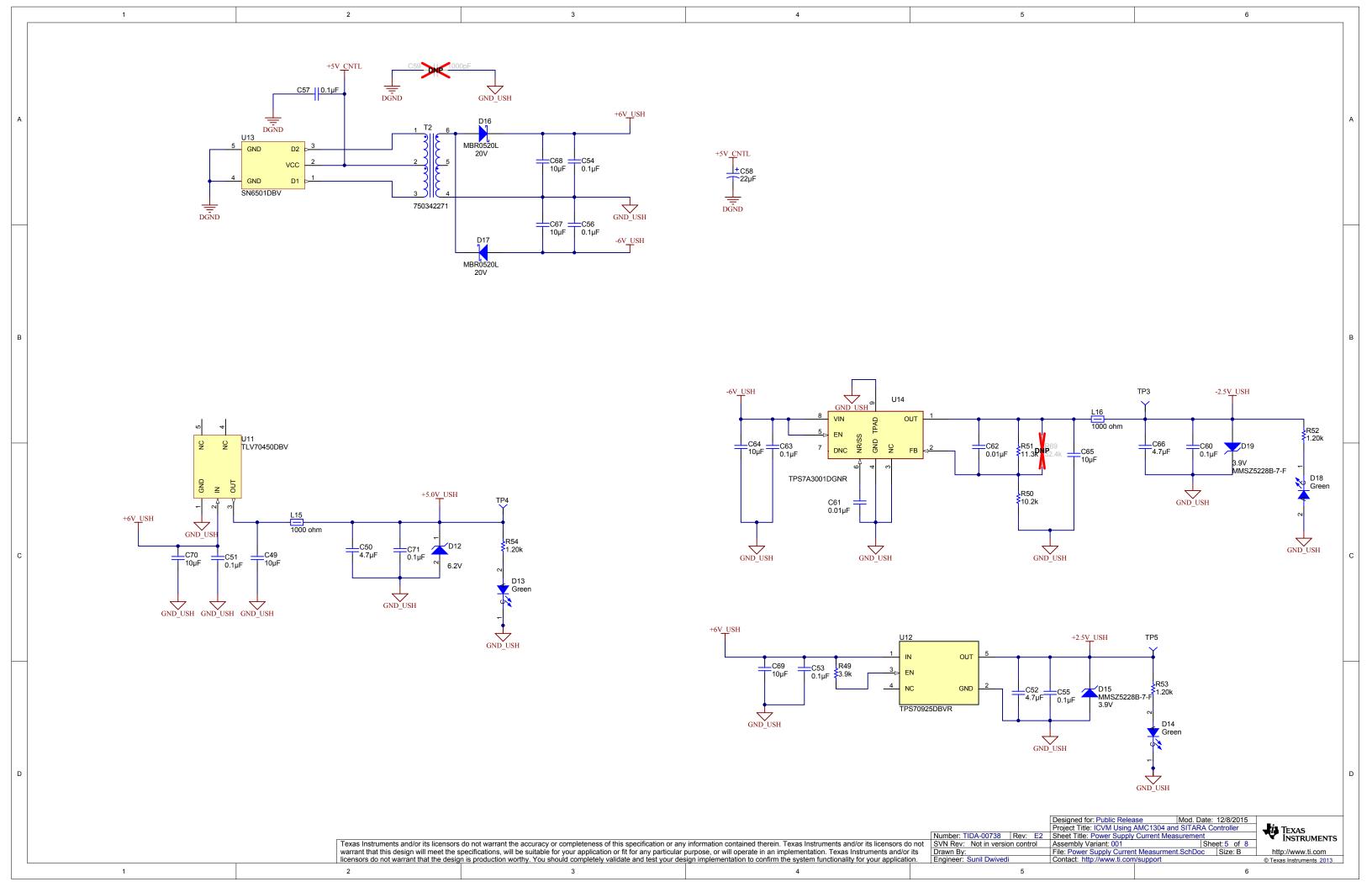
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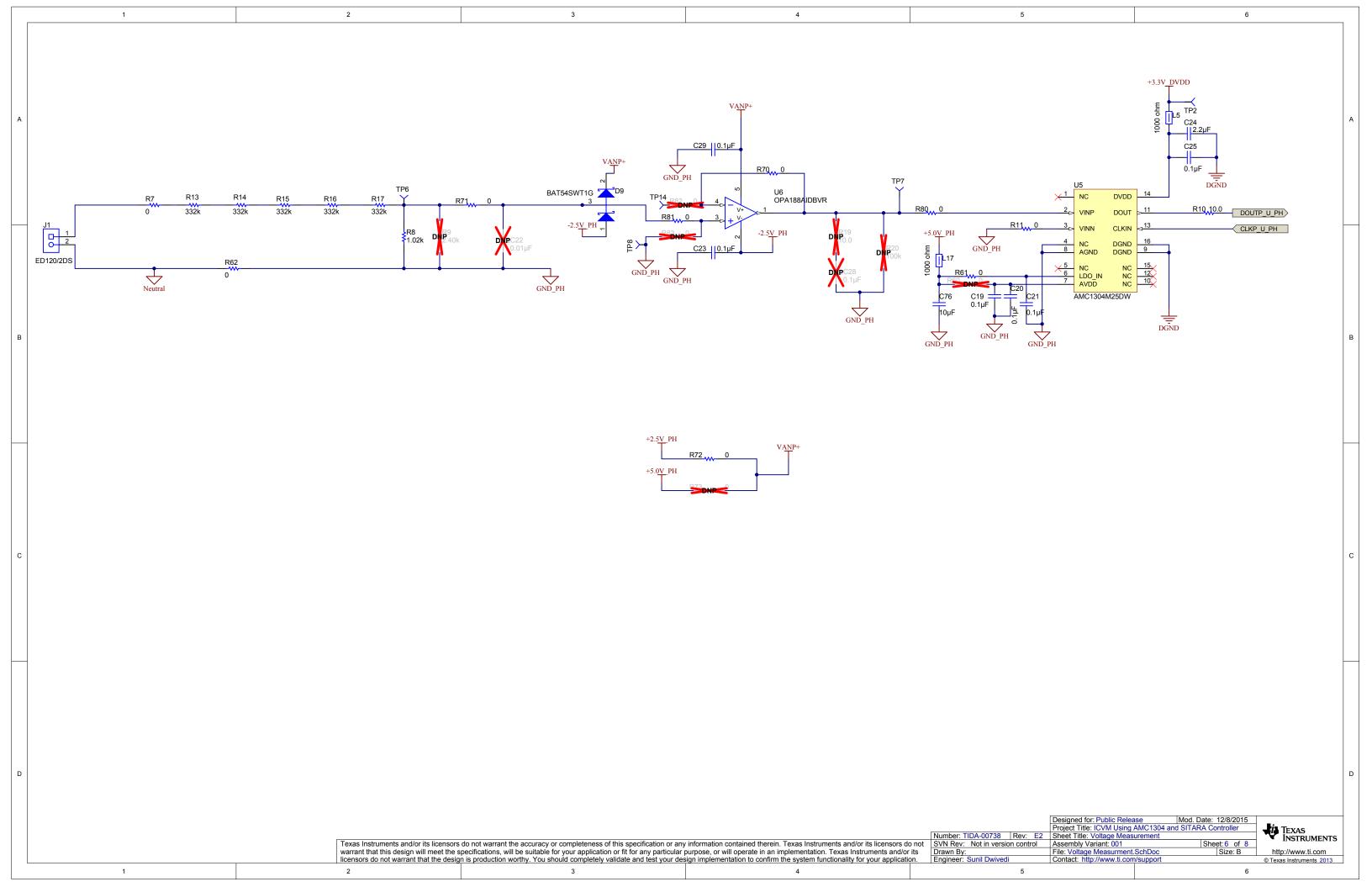
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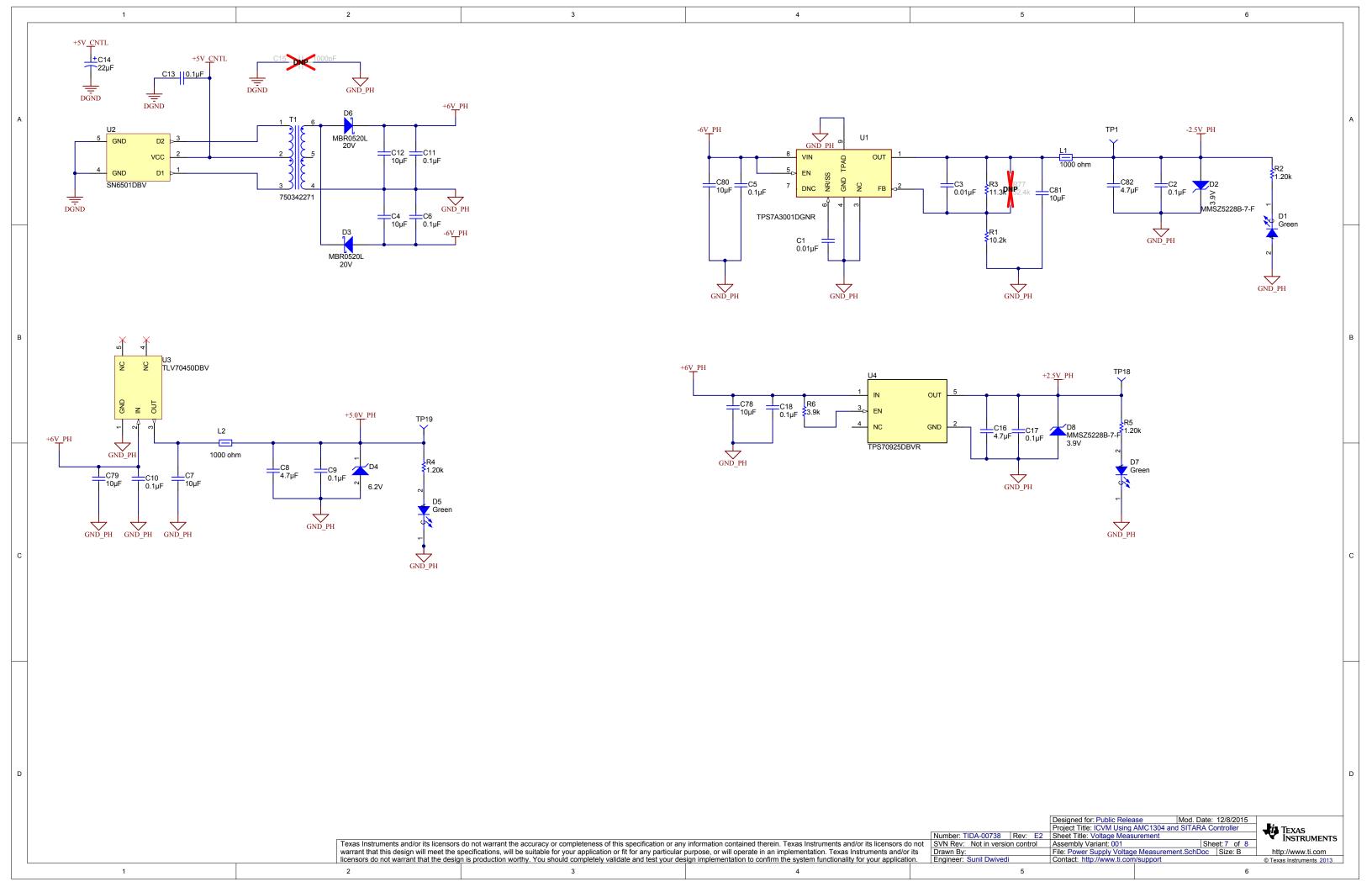
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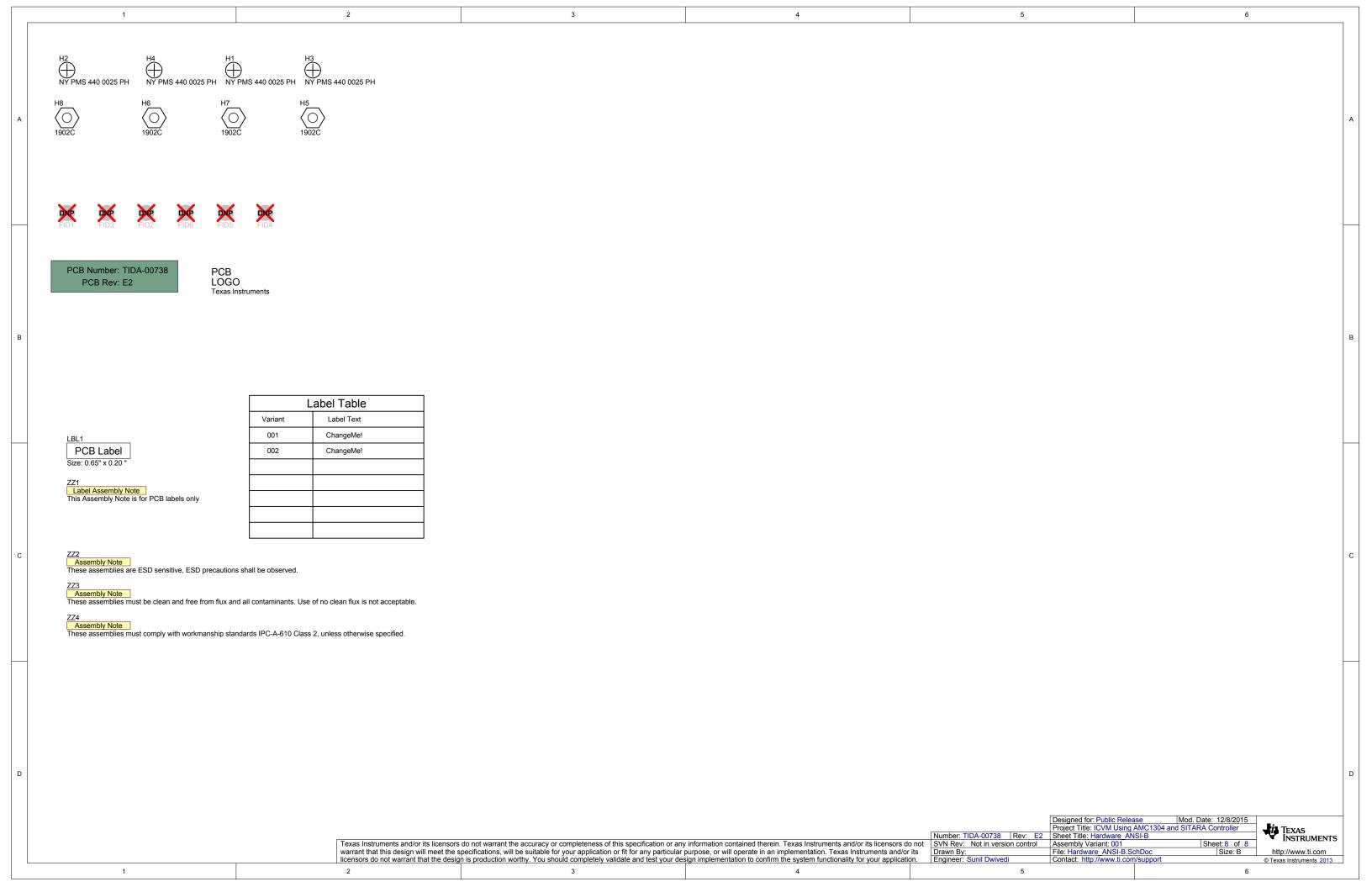












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